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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RL78
Core Size	16-Bit
Speed	24MHz
Connectivity	CSI, I²C, IrDA, LINbus, UART/USART
Peripherals	LCD, LVD, POR, PWM, WDT
Number of I/O	52
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	1.7V ~ 5.5V
Data Converters	A/D 4x10b, 3x24b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-LQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10nmjdfb-50

Table 3-6. Extended SFR (2nd SFR) List (2/11)

Address	Special Function Register (SFR) Name	Symbol		R/W	Manipulable Bit Range			After Reset
					1-bit	8-bit	16-bit	
F00F0H	Peripheral enable register 0	PER0		R/W	√	√	–	00H
F00F1H	Peripheral reset control register 0	PRR0		R/W	√	√	—	00H
F00F2H	Mid-speed on-chip oscillator frequency select register	MOCODIV		R/W	—	√	—	00H
<R> F00F3H	Subsystem clock supply option control register	OSMC		R/W	√	√	–	00H
F00F5H	RAM parity error control register	RPECTL		R/W	√	√	–	00H
<R> F00F8H	Regulator mode control register	PMMC		R/W	√	√	—	00H
F00F9H	Power-on-reset status register	PORSR		R/W	–	√	–	00H[Note]
F00FAH	Peripheral enable register 1	PER1		R/W	√	√	—	00H
F00FBH	Peripheral reset control register 1	PRR1		R/W	√	√	—	00H
F00FCH	Peripheral enable register 2	PER2		R/W	√	√	—	00H
F00FDH	Peripheral reset control register 2	PRR2		R/W	√	√	—	00H
F00FEH	BCD adjust result register	BCDADJ		R	–	√	–	Undefined
F0100H	Serial status register 00	SSR00L	SSR00	R	–	√	√	0000H
F0101H		–			–	–		
F0102H	Serial status register 01	SSR01L	SSR01	R	–	√	√	0000H
F0103H		–			–	–		
F0104H	Serial status register 02	SSR02L	SSR02	R	–	√	√	0000H
F0105H		–			–	–		
F0106H	Serial status register 03	SSR03L	SSR03	R	–	√	√	0000H
F0107H		–			–	–		
F0108H	Serial flag clear trigger register 00	SIR00L	SIR00	R/W	–	√	√	0000H
F0109H		–			–	–		
F010AH	Serial flag clear trigger register 01	SIR01L	SIR01	R/W	–	√	√	0000H
F010BH		–			–	–		
F010CH	Serial flag clear trigger register 02	SIR02L	SIR02	R/W	–	√	√	0000H
F010DH		–			–	–		
F010EH	Serial flag clear trigger register 03	SIR03L	SIR03	R/W	–	√	√	0000H
F010FH		–			–	–		
F0110H	Serial mode register 00	SMR00		R/W	–	–	√	0020H
F0111H								
F0112H	Serial mode register 01	SMR01		R/W	–	–	√	0020H
F0113H								
F0114H	Serial mode register 02	SMR02		R/W	–	–	√	0020H
F0115H								
F0116H	Serial mode register 03	SMR03		R/W	–	–	√	0020H
F0117H								
F0118H	Serial communication operation setting register 00	SCR00		R/W	–	–	√	0087H
F0119H								

Note This register is reset only by a power-on reset.

Figure 6 - 2 Format of Clock operation mode control register (CMC)

Address: FFFA0H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
CMC	EXCLK	OSCSEL	0	XT1SELEN	0	0	0	AMPH

EXCLK	OSCSEL	High-speed system clock pin operation mode	X1/P121 pin	X2/EXCLK/P122 pin
0	0	Input port mode	Input port	
0	1	X1 oscillation mode	Crystal/ceramic resonator connection	
1	0	Input port mode	Input port	
1	1	External clock input mode	Input port	External clock input

XT1SELEN	Permits or prohibits selection of the XT1 oscillation clock (f_{XT}) or external subsystem clock (f_{EXS}) as the CPU/peripheral hardware clock (f_{CLK}) Notes 1, 2, 3
0	Prohibited (switching the clock by setting the CSS bit in the CKC register is disabled).
1	Permitted (switching the clock by setting the CSS bit in the CKC register is enabled).

AMPH	Control of X1 clock oscillation frequency
0	$1\text{ MHz} \le f_X \le 10\text{ MHz}$
1	$10\text{ MHz} < f_X \le 20\text{ MHz}$

Note 1. This bit only permits switching the clock by setting the CSS bit in the CKC register. Simply setting this bit does not change the CPU/peripheral hardware clock (f_{CLK}).

Note 2. Setting this bit is not required if the low-speed on-chip oscillator clock (f_{IL}) is selected as the CPU/peripheral hardware clock (f_{CLK}).

Note 3. Be sure to write the same value as that of the OSCSELS bit in the SCMC register.

Caution 1. The CMC register can be written only once after reset release, by an 8-bit memory manipulation instruction. When using the CMC register with its initial value (00H), be sure to set the register to 00H after a reset ends in order to prevent malfunction due to a program loop. Such a malfunction becomes unrecoverable when a value other than 00H is mistakenly written.

Caution 2. After reset release, set the CMC register before X1 or XT1 oscillation is started as set by the clock operation status control register (CSC) or subsystem clock operation status control register (SCMC).

Caution 3. Be sure to set the AMPH bit to 1 if the X1 clock oscillation frequency exceeds 10 MHz.

Caution 4. Specify the settings for the AMPH bit while f_{IH} is selected as f_{CLK} after a reset ends (before f_{CLK} is switched to f_{MX} or f_{SUB}).

Caution 5. Although the maximum system clock frequency is 32 MHz, the maximum frequency of the X1 oscillator is 20 MHz.

Remark f_X: X1 clock frequency

Caution 1. Be sure to set bits 2 and 3 of the CKC register to 0.

Caution 2. The clock set by the CSS bit is supplied to the CPU and peripheral hardware. If the CPU clock is changed, therefore, the clock supplied to peripheral hardware (except the independent power supply RTC, 12-bit interval timer, clock output/buzzer output, LCD controller/driver, 8-bit interval timer, frequency measurement circuit, oscillation stop detection circuit, and watchdog timer) is also changed at the same time. Consequently, stop each peripheral function when changing the CPU/peripheral hardware clock.

Caution 3. If the subsystem clock is used as the peripheral hardware clock, the operations of the A/D converter and IICA are not guaranteed. For the operating characteristics of the peripheral hardware, refer to the chapters describing the various peripheral hardware as well as CHAPTER 41 ELECTRICAL SPECIFICATIONS.

power consumption oscillation (AMPHS1, AMPHS0 = 1, 0) is selected.

• Configure the circuit of the circuit board, using material with little parasitic capacitance and wiring resistance.

• Place a ground pattern that has the same potential as Vss as much as possible near the XT1 oscillator.

• Be sure that the signal lines between the XT1 and XT2 pins, and the resonators do not cross with the other signal lines. Do not route the wiring near a signal line through which a high fluctuating current flows.

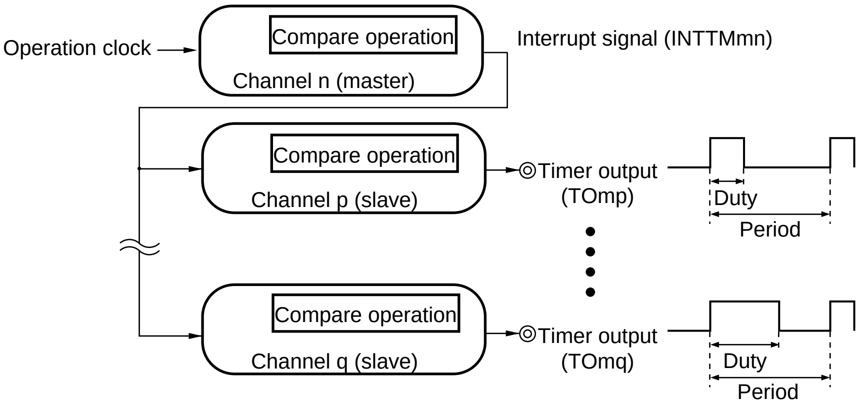
• The impedance between the XT1 and XT2 pins may drop and oscillation may be disturbed due to moisture absorption of the circuit board in a high-humidity environment or dew condensation on the board. When using the circuit board in such an environment, take measures to damp-proof the circuit board, such as by coating.

• When coating the circuit board, use material that does not cause capacitance or leakage between the XT1 and XT2 pins.

Caution 7. Be sure to clear bits 7, 6, 3, and 0 to 0.

(3) Multiple PWM (Pulse Width Modulation) output

By extending the PWM function and using one master channel and two or more slave channels, up to seven types of PWM signals that have a specific period and a specified duty factor can be generated.



Caution For details about the rules of simultaneous channel operation function, see 8.4.1 Basic rules of simultaneous channel operation function.

Remark m: Unit number (m = 0), n: Channel number (n = 0 to 7),
p, q: Slave channel number (n < p < q ≤ 7)

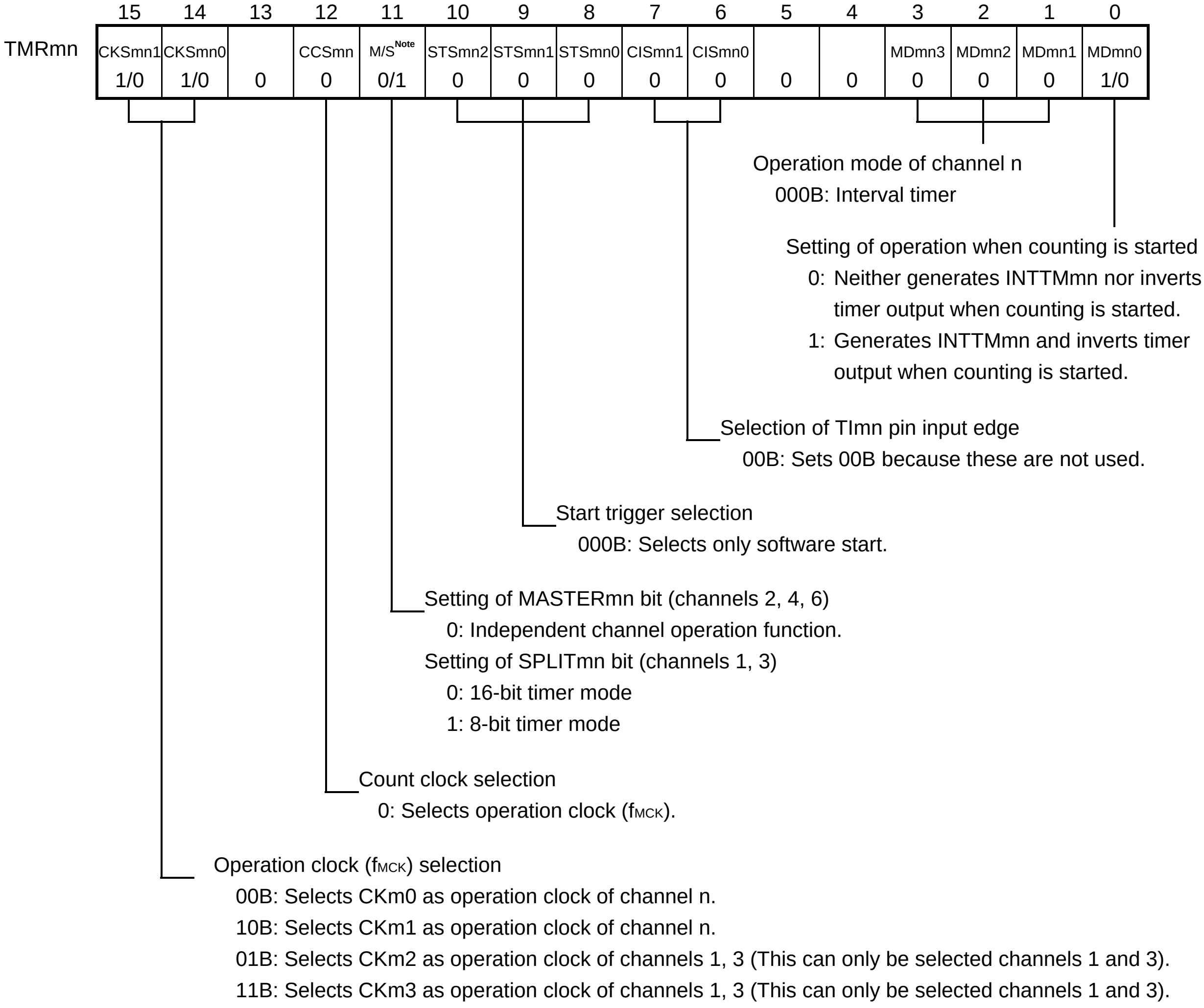
8.1.3 8-bit timer operation function (channels 1 and 3 only)

The 8-bit timer operation function makes it possible to use a 16-bit timer channel in a configuration consisting of two 8-bit timer channels. This function can only be used for channels 1 and 3.

Caution There are several rules for using 8-bit timer operation function.
For details, see 8.4.2 Basic rules of 8-bit timer operation function (channels 1 and 3 only).

Figure 8-47. Example of Set Contents of Registers During Operation as Interval Timer/Square Wave Output (1/2)

(a) Timer mode register mn (TMRmn)



	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TMRmn	CKSmn1	CKSmn0		CCSmn	M/S[Note]	STSmn2	STSmn1	STSmn0	CISmn1	CISmn0			MDmn3	MDmn2	MDmn1	MDmn0
	1/0	1/0	0	0	0/1	0	0	0	0	0	0	0	0	0	0	1/0

Operation mode of channel n
000B: Interval timer

Setting of operation when counting is started
0: Neither generates INTTMmn nor inverts timer output when counting is started.
1: Generates INTTMmn and inverts timer output when counting is started.

Selection of TImn pin input edge
00B: Sets 00B because these are not used.

Start trigger selection
000B: Selects only software start.

Setting of MASTERmn bit (channels 2, 4, 6)
0: Independent channel operation function.
Setting of SPLITmn bit (channels 1, 3)
0: 16-bit timer mode
1: 8-bit timer mode

Count clock selection
0: Selects operation clock (f_{MCK}).

Operation clock (f_{MCK}) selection
00B: Selects CKm0 as operation clock of channel n.
10B: Selects CKm1 as operation clock of channel n.
01B: Selects CKm2 as operation clock of channels 1, 3 (This can only be selected channels 1 and 3).
11B: Selects CKm3 as operation clock of channels 1, 3 (This can only be selected channels 1 and 3).

(b) Timer output register m (TOm)

	Bit n
TOm	TOmn
	1/0

0: Outputs 0 from TOmn.
1: Outputs 1 from TOmn.

(c) Timer output enable register m (TOEm)

	Bit n
TOEm	TOEmn
	1/0

0: Stops the TOmn output operation by counting operation.
1: Enables the TOmn output operation by counting operation.

Note TMRm2, TMRm4, TMRm6: MASTERmn bit
TMRm1, TMRm3: SPLITmn bit
TMRm0, TMRm5, TMRm7: Fixed to 0

Remark m: Unit number (m = 0), n: Channel number (n = 0 to 7)

Figure 8-48. Operation Procedure of Interval Timer/Square Wave Output Function (2/2)

	Software Operation	Hardware Status
TAU stop	To hold the TOmn pin output level Clears the TOmn bit to 0 after the value to be held is set to the port register. When holding the TOmn pin output level is not necessary Setting not required.	The TOmn pin output level is held by port function.
	The TAUmEN bit of the PER0 register is cleared to 0.	Power-off status All circuits are initialized and SFR of each channel is also initialized. (The TOmn bit is cleared to 0 and the TOmn pin is set to port mode.)

Remark m: Unit number (m = 0), n: Channel number (n = 0 to 7)

Figure 8-52. Operation Procedure When External Event Counter Function Is Used

	Software Operation	Hardware Status
TAU default setting		Power-off status (Clock supply is stopped and writing to each register is disabled.)
	Sets the TAUmEN bit of peripheral enable register 0 (PER0) to 1.	Power-on status. Each channel stops operating. (Clock supply is started and writing to each register is enabled.)
	Sets timer clock select register m (TPSm). Determines clock frequencies of CKm0 to CKm3.	
Channel default setting	Sets the corresponding bit of the noise filter enable register 1 (NFEN1) to 0 (off) or 1 (on). Sets timer mode register mn (TMRmn) (determines operation mode of channel). Sets number of counts to timer data register mn (TDRmn). Clears the TOEmn bit of timer output enable register m (TOEm) to 0.	Channel stops operating. (Clock is supplied and some power is consumed.)
Operation start	Sets the TSmn bit to 1. The TSmn bit automatically returns to 0 because it is a trigger bit.	TEmn = 1, and count operation starts. Value of the TDRmn register is loaded to timer count register mn (TCRmn) and detection of the TImn pin input edge is awaited.
During operation	Set value of the TDRmn register can be changed. The TCRmn register can always be read. The TSRmn register is not used. Set values of the TMRmn register, TOMmn, TOLmn, TOmn, and TOEmn bits cannot be changed.	Counter (TCRmn) counts down each time input edge of the TImn pin has been detected. When count value reaches 0000H, the value of the TDRmn register is loaded to the TCRmn register again, and the count operation is continued. By detecting TCRmn = 0000H, the INTTMmn output is generated. After that, the above operation is repeated.
Operation stop	The TTmn bit is set to 1. The TTmn bit automatically returns to 0 because it is a trigger bit.	TEmn = 0, and count operation stops. The TCRmn register holds count value and stops.
TAU stop	The TAUmEN bit of the PER0 register is cleared to 0.	Power-off status All circuits are initialized and SFR of each channel is also initialized.

Operation is resumed.

Remark m: Unit number (m = 0), n: Channel number (n = 0 to 7)

Figure 8-78. Example of Set Contents of Registers When Multiple PWM Output Function (Slave Channel) Is Used (Output Two Types of PWMs)

(a) Timer mode register mp, mq (TMRmp, TMRmq)

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TMRmp	CKSmp1 1/0	CKSmp0 0	0	CCSmp 0	M/S[Note] 0	STSmp2 1	STSmp1 0	STSmp0 0	CISmp1 0	CISmp0 0	0	0	MDmp3 1	MDmp2 0	MDmp1 0	MDmp0 1

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TMRmq	CKSmq1 1/0	CKSmq0 0	0	CCSmq 0	M/S[Note] 0	STSmq2 1	STSmq1 0	STSmq0 0	CISmq1 0	CISmq0 0	0	0	MDmq3 1	MDmq2 0	MDmq1 0	MDmq0 1

Operation mode of channel p, q
100B: One-count mode

Start trigger during operation
1: Trigger input is valid.

Selection of TImp and TImq pins input edge
00B: Sets 00B because these are not used.

Start trigger selection
100B: Selects INTTMmn of master channel.

Setting of MASTERmp and MASTERmq bits (channels 2, 4, 6)
0: Slave channel.

Setting of SPLITmp and SPLITmq bits (channels 1, 3)
0: 16-bit timer mode.

Count clock selection
0: Selects operation clock (f_{MCK}).

Operation clock (f_{MCK}) selection
00B: Selects CKm0 as operation clock of channel p, q.
10B: Selects CKm1 as operation clock of channel p, q.
* Make the same setting as master channel.

(b) Timer output register m (TOm)

	Bit q	Bit p
TOm	TOmq 1/0	TOmp 1/0

0: Outputs 0 from TOmp or TOmq.
1: Outputs 1 from TOmp or TOmq.

(c) Timer output enable register m (TOEm)

	Bit q	Bit p
TOEm	TOEmq 1/0	TOEmp 1/0

0: Stops the TOmp or TOmq output operation by counting operation.
1: Enables the TOmp or TOmq output operation by counting operation.

(d) Timer output level register m (TOLm)

	Bit q	Bit p
TOLm	TOLmq 1/0	TOLmp 1/0

0: Positive logic output (active-high)
1: Negative logic output (active-low)

(e) Timer output mode register m (TOMm)

	Bit q	Bit p
TOMm	TOMmq 1	TOMmp 1

1: Sets the slave channel output mode.

Note	
TMRm2, TMRm4, TMRm6:	MASTERmp, MASTERmq bit
TMRm1, TMRm3:	SPLITmp, SPLIT0q bit
TMRm5, TMRm7:	Fixed to 0

Remark m: Unit number (m = 0), n: Channel number (n = 0, 2, 4)
p: Slave channel number, q: Slave channel number
$n < p < q \leq 7$ (Where p and q are integers greater than n)

Table 9 - 2 Pin Configuration of RTC

Pin Name	I/O	Function
XT1	Input	Connecting a 32.768-kHz crystal vibrator.
XT2	Input	
EXCLKS	Input	Connecting a 32.768-kHz external clock input.
RTCOUT	Output	1 or 64-Hz waveform output pin.
RTCIC0	Input	Time capture event input pins
RTCIC1	Input	
RTCIC2	Input	

15.6.10 Hardware trigger wait mode (select mode, one-shot conversion mode)

<1> In the stop status, the ADCE bit of A/D converter mode register 0 (ADM0) is set to 1, and the system enters the hardware trigger standby status.

<2> If a hardware trigger is input while in the hardware trigger standby status, A/D conversion is performed on the analog input specified by the analog input channel specification register (ADS). The ADCS bit of the ADM0 register is automatically set to 1 according to the hardware trigger input.

<3> When A/D conversion ends, the conversion result is stored in the A/D conversion result register (ADCR, ADCRH), and the A/D conversion end interrupt request signal (INTAD) is generated.

<4> After A/D conversion ends, the ADCS bit is automatically cleared to 0, and the A/D converter enters the stop status.

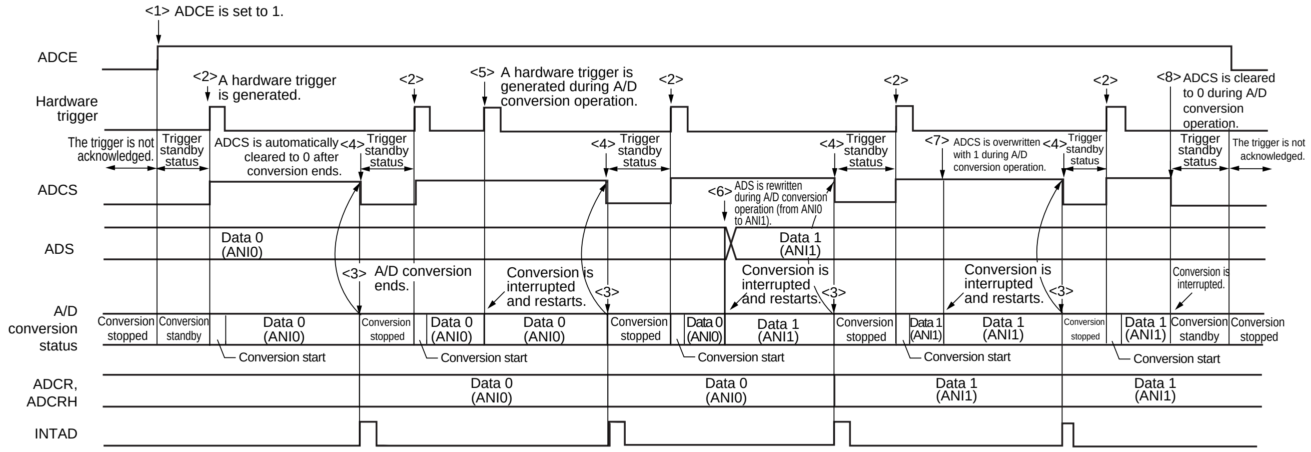
<5> If a hardware trigger is input during conversion operation, the current A/D conversion is interrupted, and conversion restarts. The partially converted data is discarded.

<6> When the value of the ADS register is rewritten or overwritten during conversion operation, the current A/D conversion is interrupted, and A/D conversion is performed on the analog input respecified by the ADS register. The partially converted data is discarded.

<7> When ADCS is overwritten with 1 during conversion operation, the current A/D conversion is interrupted, and conversion restarts. The partially converted data is initialized.

<8> When ADCS is cleared to 0 during conversion operation, the current A/D conversion is interrupted, the system enters the hardware trigger standby status, and the A/D converter enters the stop status. When ADCE = 0, inputting a hardware trigger is ignored and A/D conversion does not start.

Figure 15-27. Example of Hardware Trigger Wait Mode (Select Mode, One-shot Conversion Mode) Operation Timing



Notes 1. The number of bits used as the shift register and buffer register differs depending on the unit and channel.

• mn = 00, 01:	lower 9 bits
• Other than above:	lower 8 bits

2. The lower 8 bits of serial data register mn (SDRmn) can be read or written as the following SFR, depending on the communication mode.

- CSIp communication … SIOp (CSIp data register)
- UARTq reception … RXDq (UARTq receive data register)
- UARTq transmission … TXDq (UARTq transmit data register)
- IICr communication … SIOr (IICr data register)

Remark m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3), p: CSI number (p = 00, 10, 30), q: UART number (q = 0 to 3), r: IIC number (r = 00, 10, 30), mn = 00 to 03, 10 to 13

Table 18-5. Selection of Operation Clock For Simplified I^2C

SMRmn Register	SPSm Register								Operation Clock (f_{MCK})[Note]	
CKSmn	PRS m13	PRS m12	PRS m11	PRS m10	PRS m03	PRS m02	PRS m01	PRS m00		f_{CLK} = 24 MHz
0	X	X	X	X	0	0	0	0	f_{CLK}	24 MHz
	X	X	X	X	0	0	0	1	$f_{CLK}/2$	12 MHz
	X	X	X	X	0	0	1	0	$f_{CLK}/2^2$	6 MHz
	X	X	X	X	0	0	1	1	$f_{CLK}/2^3$	3 MHz
	X	X	X	X	0	1	0	0	$f_{CLK}/2^4$	1.5 MHz
	X	X	X	X	0	1	0	1	$f_{CLK}/2^5$	750 kHz
	X	X	X	X	0	1	1	0	$f_{CLK}/2^6$	375 kHz
	X	X	X	X	0	1	1	1	$f_{CLK}/2^7$	187.5 kHz
	X	X	X	X	1	0	0	0	$f_{CLK}/2^8$	93.8 kHz
	X	X	X	X	1	0	0	1	$f_{CLK}/2^9$	46.9 kHz
	X	X	X	X	1	0	1	0	$f_{CLK}/2^{10}$	23.4 kHz
	X	X	X	X	1	0	1	1	$f_{CLK}/2^{11}$	11.7 kHz
1	0	0	0	0	X	X	X	X	f_{CLK}	24 MHz
	0	0	0	1	X	X	X	X	$f_{CLK}/2$	12 MHz
	0	0	1	0	X	X	X	X	$f_{CLK}/2^2$	6 MHz
	0	0	1	1	X	X	X	X	$f_{CLK}/2^3$	3 MHz
	0	1	0	0	X	X	X	X	$f_{CLK}/2^4$	1.5 MHz
	0	1	0	1	X	X	X	X	$f_{CLK}/2^5$	750 kHz
	0	1	1	0	X	X	X	X	$f_{CLK}/2^6$	375 kHz
	0	1	1	1	X	X	X	X	$f_{CLK}/2^7$	187.5 kHz
	1	0	0	0	X	X	X	X	$f_{CLK}/2^8$	93.8 kHz
	1	0	0	1	X	X	X	X	$f_{CLK}/2^9$	46.9 kHz
	1	0	1	0	X	X	X	X	$f_{CLK}/2^{10}$	23.4 kHz
	1	0	1	1	X	X	X	X	$f_{CLK}/2^{11}$	11.7 kHz
Other than above									Setting prohibited	

Note When changing the clock selected for f_{CLK} (by changing the system clock control register (CKC) value), do so after having stopped (serial channel stop register m (STm) = 000FH) the operation of the serial array unit (SAU).

Remarks 1. X: Don’t care

2. m: Unit number (m = 0, 1), n: Channel number (n = 0, 2), mn = 00, 02, 12

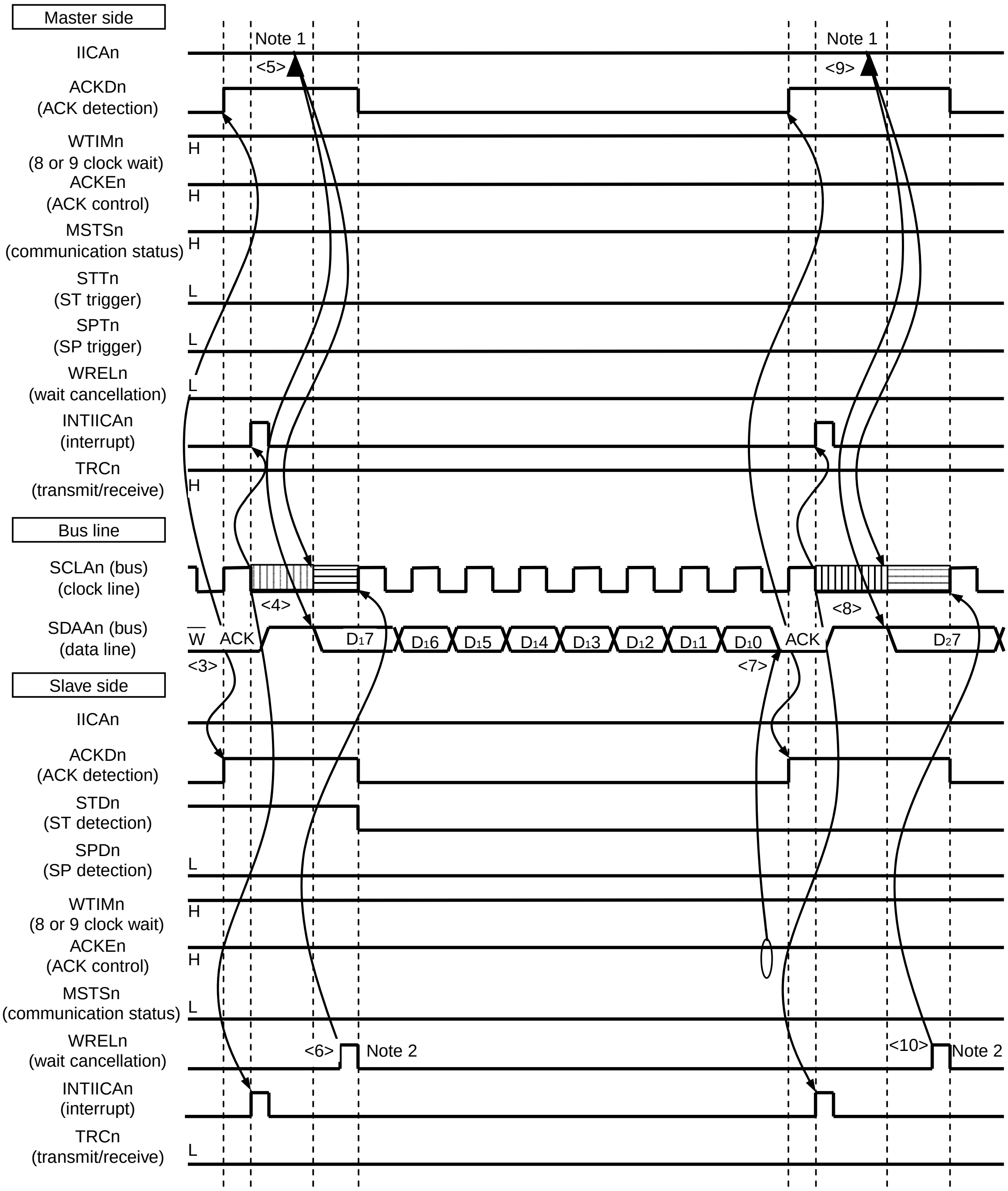
Here is an example of setting an I^2C transfer rate where f_{MCK} = f_{CLK} = 24 MHz.

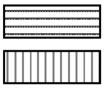
I^2C Transfer Mode (Desired Transfer Rate)	f_{CLK} = 24 MHz			
	Operation Clock (f_{MCK})	SDRmn[15:9]	Calculated Transfer Rate	Error from Desired Transfer Rate
100 kHz	$f_{CLK}/2$	59	100 kHz	0.0%
400 kHz	f_{CLK}	29	380 kHz	5.0%[Note]
1 MHz	f_{CLK}	5	0.84 MHz	16.0%[Note]

Note The error cannot be set to about 0% because the duty ratio of the SCL signal is 50%.

Figure 19-33. Example of Master to Slave Communication (9-Clock Wait Is Selected for Master, 9-Clock Wait Is Selected for Slave) (2/4)

(2) Address ~ data ~ data




: Wait state by slave device
: Wait state by master and slave devices

Notes 1. Write data to IICAn, not setting the WRELn bit, in order to cancel a wait state during transmission by a master device.

2. For releasing wait state during reception of a slave device, write “FFH” to IICAn or set the WRELn bit.

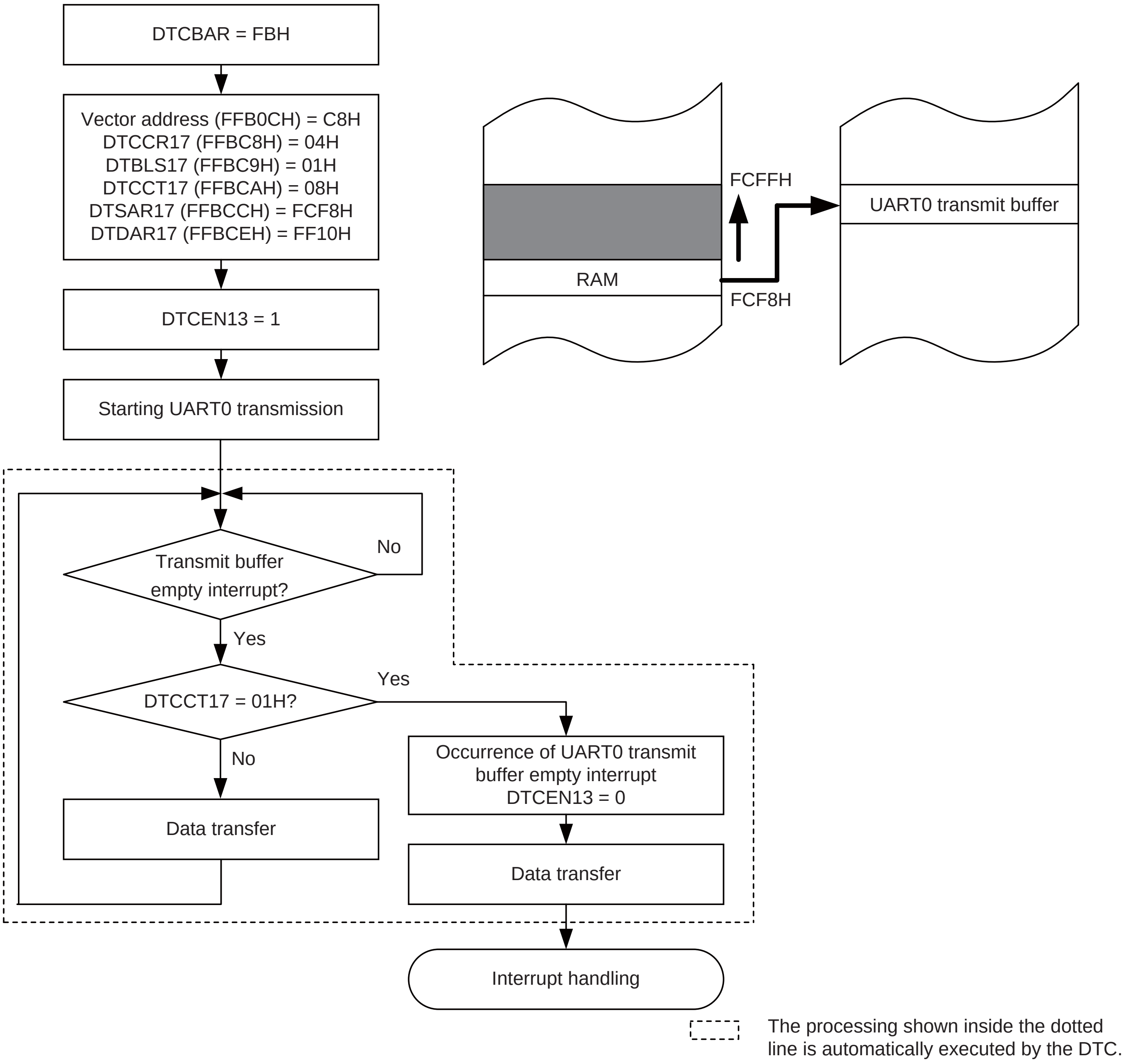
Remark n = 0

(2) Example 2 of using normal mode: UART0 consecutive transmission

The DTC is activated by a UART0 transmit buffer empty interrupt and the value of RAM is transferred to the UART0 transmit buffer.

- The vector address is FFB0CH and control data is allocated at FFBC8H to FFBCFH
- Transfers 8 bytes of FFCF8H to FFCFFH of RAM to the UART0 transmit buffer (FFF10H)

Figure 22-17. Example 2 of Using Normal Mode: UART0 Consecutive Transmission



The value of the DTRLD17 register is not used because of normal mode, but initialize the register to 00H when parity error resets are enabled (RPERDIS = 0) using the RAM parity error detection function.
Start the first UART0 transmission by software. The second and subsequent transmissions are automatically sent when the DTC is activated by a transmit buffer empty interrupt.

22.5 Notes on DTC

22.5.1 Setting DTC control data and vector table

- Do not access the DTC SFRs, the DTC control data area, the DTC vector table area, or the general-register (FFEE0H to FFEFFH) space using a DTC transfer.
- Modify the DTC base address register (DTCBAR) while all DTC activation sources are set to activation disabled.
- Do not rewrite the DTC base address register (DTCBAR) twice or more.
- Modify the data of the DTCCRj, DTBLSj, DTCCTj, DTRLDj, DTSARj, or DTDARj register when the corresponding bit among bits DTCENi0 to DTCENi7 in the DTCENi (i = 0 to 4) register is 0 (DTC activation disabled).
- Modify the start address of the DTC control data area to be set in the vector table when the corresponding bit among bits DTCENi0 to DTCENi7 in the DTCENi (i = 0 to 4) register is 0 (DTC activation disabled).
- Do not allocate RAM addresses which are used as a DTC transfer destination/transfer source to the area FFE20H to FFEDFH when performing self-programming and rewriting the data flash memory.

22.5.2 Allocation of DTC control data area and DTC vector table area

The areas where the DTC control data and vector table can be allocated differ.

- It is prohibited to use the general-purpose register (FFEE0H to FFEFFH) space as the DTC control data area or DTC vector table area.
- Make sure the stack area, the DTC control data area, and the DTC vector table area do not overlap.
- The internal RAM area in the following products cannot be used as the DTC control data area or DTC vector table area when using the self-programming and data-flash functions.
  R5F10NMJ, R5F10NPJ: FBF00H to FC309H
  <R> R5F10NMG, R5F10NLG: FDF00H to FE309H
- The internal RAM area in the following products cannot be used as the DTC control data area or DTC vector table area when using the on-chip trace function.
  R5F10NMJ, R5F10NPJ: FC300H to FC6FFH
  <R> R5F10NMG, R5F10NLG: FE300H to FE6FFH
- Initialize the DTRLD register to 00H even in normal mode when parity error resets are enabled (RPERDIS = 0) using the RAM parity error detection function.

22.5.3 DTC pending instruction

Even if a DTC transfer request is generated, data transfer is held pending immediately after the following instructions. Also, the DTC is not activated between PREFIX instruction code and the instruction immediately after that code.

- Call/return instruction
- Unconditional branch instruction
- Conditional branch instruction
- Read access instruction for code flash memory
- Bit manipulation instructions for IFxx, MKxx, PRxx, and PSW, and an 8-bit manipulation instruction that has the ES register as operand
- Instruction for accessing the data flash memory
- Instruction of Multiply, Divide, Multiply & Accumulate (excluding MULU)

Cautions 1. When a DTC transfer request is acknowledged, all interrupt requests are held pending until DTC transfer is completed.

2. While the DTC is held pending by the DTC pending instruction, all interrupt requests are held pending.

Table 23 - 2 Correspondence Between ELSELRn (n = 00 to 21) Registers and Peripheral Functions

Register Name	Event Generator (Output Origin of Event Input n)	Event Description
ELSELR00	External interrupt edge detection 0	INTP0
ELSELR01	External interrupt edge detection 1	INTP1
ELSELR02	External interrupt edge detection 2	INTP2
ELSELR03	External interrupt edge detection 3	INTP3
ELSELR04	External interrupt edge detection 4	INTP4
ELSELR05	External interrupt edge detection 5	INTP5
ELSELR06	External interrupt edge detection 6	INTP6
ELSELR07	External interrupt edge detection 7	INTP7
ELSELR08	Key return signal detection	INTKR
ELSELR09	12-bit interval timer interval signal detection	INTIT
ELSELR10	8-bit interval timer channel 00 compare match or 16-bit interval timer channel 0 compare match (cascaded)	INTIT00
ELSELR11	8-bit interval timer channel 10 compare match or 16-bit interval timer channel 1 compare match (cascaded)	INTIT10
<R> ELSELR12	Fixed-cycle signal of real-time clock	INTRTCPRD
ELSELR13	TAU channel 00 count end/capture end	INTTM00
ELSELR14	TAU channel 01 count end/capture end	INTTM01
ELSELR15	TAU channel 02 count end/capture end	INTTM02
ELSELR16	TAU channel 03 count end/capture end	INTTM03
ELSELR17	TAU channel 05 count end/capture end	INTTM05
ELSELR18	TAU channel 07 count end/capture end	INTTM07
ELSELR19	24-bit ΔΣ-type A/D conversion end	INTDSAD
ELSELR20	Zero-cross detection 0 of 24-bit ΔΣ-type A/D converter	INTDSADZC0
ELSELR21	Zero-cross detection 1 of 24-bit ΔΣ-type A/D converter	INTDSADZC1

Figure 29 - 8 Format of User Option Byte (000C1H/010C1H) (1/2)

Address: 000C1H/010C1H[Note]

7	6	5	4	3	2	1	0
VPOC2	VPOC1	VPOC0	1	LVIS1	LVIS0	LVIMDS1	LVIMDS0

- LVD setting (interrupt & reset mode)

Detection voltage			Option byte Setting Value						
VLVDH		VLVDL	VPOC2	VPOC1	VPOC0	LVIS1	LVIS0	Mode setting	
Rising edge	Falling edge	Falling edge						LVIMDS1	LVIMDS0
1.77 V	1.73 V	1.63 V	0	0	0	1	0	1	0
1.88 V	1.84 V					0	1		
2.92 V	2.86 V					0	0		
1.98 V	1.94 V	1.84 V		0	1	1	0		
2.09 V	2.04 V					0	1		
3.13 V	3.06 V					0	0		
2.61 V	2.55 V	2.45 V		1	0	1	0		
2.71 V	2.65 V					0	1		
2.92 V	2.86 V	2.75 V		1	1	1	0		
3.02 V	2.96 V					0	1		
—			Settings other than the above are prohibited						

- LVD setting (reset mode)

Detection voltage		Option byte Setting Value						
VLVD		VPOC2	VPOC1	VPOC0	LVIS1	LVIS0	Mode setting	
Rising edge	Falling edge						LVIMDS1	LVIMDS0
1.67 V	1.63 V	0	0	0	1	1	1	1
1.77 V	1.73 V		0	0	1	0		
1.88 V	1.84 V		0	1	1	1		
1.98 V	1.94 V		0	1	1	0		
2.09 V	2.04 V		0	1	0	1		
2.50 V	2.45 V		1	0	1	1		
2.61 V	2.55 V		1	0	1	0		
2.71 V	2.65 V		1	0	0	1		
2.81 V	2.75 V		1	1	1	1		
2.92 V	2.86 V		1	1	1	0		
3.02 V	2.96 V		1	1	0	1		
3.13 V	3.06 V		0	1	0	0		
—		Settings other than the above are prohibited						

Note Set the same value as 000C1H to 010C1H when the boot swap operation is used because 000C1H is replaced by 010C1H.

Remark 1. For details on the LVD circuit, see **CHAPTER 29 VOLTAGE DETECTOR**.

Remark 2. The detection voltage is a TYP. value. For details, see **41.6.5 LVD circuit characteristics**.

(**Cautions** are listed on the next page.)

36.4.3 Selecting communication mode

Communication mode of the RL78 microcontroller as follows.

Table 36 - 6 Communication Modes

Communication Mode	Standard Setting Note 1				Pins Used
	Port	Speed Note 2	Frequency	Multiply Rate	
1-line mode (when flash memory programmer is used, or when external device is used)	UART	115200 bps, 250000 bps, 500000 bps, 1 Mbps	—	—	TOOL0
Dedicated UART (when external device is used)	UART	115200 bps, 250000 bps, 500000 bps, 1 Mbps	—	—	TOOLTxD, TOOLRxD

Note 1. Selection items for Standard settings on GUI of the flash memory programmer.

Note 2. Because factors other than the baud rate error, such as the signal waveform slew, also affect UART communication, thoroughly evaluate the slew as well as the baud rate error.

(T_A = –40 to +85°C, 1.7 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD}[Note 4] ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V)

Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Output current, low[Note 1]	I_{OL1}	Per pin for P02 to P07, P10 to P17, P30 to P37, P40 to P43, P50 to P57, P70 to P77, P80 to P85, P125 to P127				20.0[Note 2]	mA
		Per pin for P60 to P62				15.0[Note 2]	mA
		Total of P02 to P07, P40 to P43 (When duty = 70%[Note 3])	4.0 V ≤ EV_{DD} ≤ 5.5 V			70.0	mA
			2.7 V ≤ EV_{DD} < 4.0 V			15.0	mA
			1.9 V ≤ EV_{DD} < 2.7 V			9.0	mA
			1.7 V ≤ EV_{DD} < 1.9 V			4.5	mA
		Total of P10 to P17, P30 to P37, P50 to P57, P60 to P62, P70 to P77, P80 to P85, P125 to P127 (When duty = 70%[Note 3])	4.0 V ≤ EV_{DD} ≤ 5.5 V			80.0	mA
			2.7 V ≤ EV_{DD} < 4.0 V			35.0	mA
			1.9 V ≤ EV_{DD} < 2.7 V			20.0	mA
			1.7 V ≤ EV_{DD} < 1.9 V			10.0	mA
		Total of all pins (When duty = 70%[Note 3])				150.0	mA
	I_{OL2}	Per pin for P20 to P25, P150 to P152	1.7 V ≤ V_{DD}[Note 4] ≤ 5.5 V			0.4[Note 2]	mA
		Total of all pins (When duty = 70%[Note 3])	1.7 V ≤ V_{DD}[Note 4] ≤ 5.5 V			3.6	mA

Notes 1. Value of current at which the device operation is guaranteed even if the current flows from an output pin to the EV_{SS} and V_{SS} pins.

2. However, do not exceed the total current value.

3. Specification under conditions where the duty factor ≤ 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = (I_{OL} × 0.7)/(n × 0.01)

<Example> Where n = 80% and I_{OL} = 10.0 mA

Total output current of pins = (10.0 × 0.7)/(80 × 0.01) ≅ 8.7 mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

4. Either V_{DD} or VBAT is selected by the battery backup function.

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.